

General Description

The CMS65N03 uses advanced trench technology to provide excellent $R_{DS(ON)}$. This device is suitable for use as a synchronous switch in PWM applications.

Features

- $R_{DS(ON)} \leq 6.8\text{m}\Omega$ @ $V_{GS}=10\text{V}$
- $R_{DS(ON)} \leq 12\text{m}\Omega$ @ $V_{GS}=4.5\text{V}$
- Surface mount package.
- RoHS Compliant

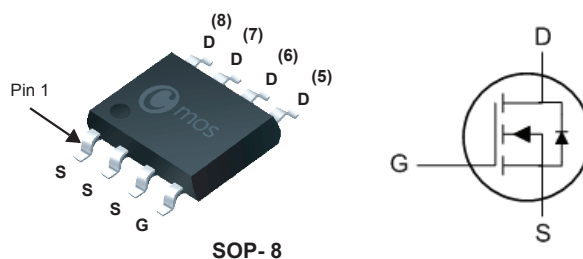
Product Summary

| BVDSS | RDSON | ID |
|-------|---------------|-----|
| 30V | 6.8m Ω | 13A |

Applications

- DC/DC Converter
- Synchronous Rectifier
- Load Switch
- Battery protection

SOP-8 Pin Configuration



| Type | Package | Marking |
|----------|---------|----------|
| CMS65N03 | SOP- 8 | CMS65N03 |

Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ Unless Otherwise Noted)

| Symbol | Parameter | Rating | Units |
|-----------|---|------------|------------------|
| V_{DS} | Drain-Source Voltage | 30 | V |
| V_{GS} | Gate-Source Voltage | ± 20 | V |
| I_D | Continuous Drain Current | 13 | A |
| I_{DM} | Pulsed Drain Current | 52 | A |
| EAS | Single Pulse Avalanche Energy Note 1 | 120 | mJ |
| P_D | Total Power Dissipation | 2 | W |
| T_{STG} | Storage Temperature Range | -55 to 150 | $^\circ\text{C}$ |
| T_J | Operating Junction Temperature Range | -55 to 150 | $^\circ\text{C}$ |

Thermal Data

| Symbol | Parameter | Typ. | Max. | Unit |
|-----------------|---|------|------|---------------------------|
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient | --- | 50 | $^\circ\text{C}/\text{W}$ |

N-Channel Enhancement Mode MOSFET

Electrical Characteristics ($T_J=25^{\circ}\text{C}$, unless otherwise noted)

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|--------------|-----------------------------------|---|------|------|-----------|------------|
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{GS}=0V$, $I_D=250\mu A$ | 30 | --- | --- | V |
| $R_{DS(ON)}$ | Static Drain-Source On-Resistance | $V_{GS}=10V$, $I_D=12A$ | --- | --- | 6.8 | m Ω |
| | | $V_{GS}=4.5V$, $I_D=8A$ | --- | --- | 12 | |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{GS}=V_{DS}$, $I_D=250\mu A$ | 1 | --- | 3 | V |
| I_{DSS} | Drain-Source Leakage Current | $V_{DS}=24V$, $V_{GS}=0V$ | --- | --- | 1 | μA |
| I_{GSS} | Gate-Source Leakage Current | $V_{GS}=\pm 20V$, $V_{DS}=0V$ | --- | --- | ± 100 | nA |
| g_{fs} | Forward Transconductance | $V_{DS}=5V$, $I_D=8A$ | --- | 18 | --- | S |
| Q_g | Total Gate Charge | $V_{DD}=15V$, $I_D=16A$ $V_{GS}=0$ to $4.5V$ | --- | 15 | --- | nC |
| Q_{gs} | Gate-Source Charge | | --- | 6.5 | --- | |
| Q_{gd} | Gate-Drain Charge | | --- | 3.5 | --- | |
| $T_{d(on)}$ | Turn-On Delay Time | $V_{DD}=15V$, $V_{GS}=4.5V$, $I_D=16A$ $R_G=1.6\Omega$ | --- | 12.5 | --- | ns |
| T_r | Rise Time | | --- | 6.5 | --- | |
| $T_{d(off)}$ | Turn-Off Delay Time | | --- | 15.5 | --- | |
| T_f | Fall Time | | --- | 6.5 | --- | |
| C_{iss} | Input Capacitance | $V_{DS}=10V$, $V_{GS}=0V$, $f=1MHz$ | --- | 2000 | --- | pF |
| C_{oss} | Output Capacitance | | --- | 710 | --- | |
| C_{rss} | Reverse Transfer Capacitance | | --- | 50 | --- | |

Diode Characteristics

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|----------|---------------------------|--|------|------|------|------|
| I_S | Continuous Source Current | $V_G=V_D=0V$, Force Current | --- | --- | 13 | A |
| I_{SM} | Pulsed Source Current | | --- | --- | 40 | A |
| V_{SD} | Diode Forward Voltage | $V_{GS}=0V$, $I_S=12A$, $T_J=25^{\circ}\text{C}$ | --- | --- | 1.2 | V |

Note :

1.The test condition is $V_{DD}=15V$, $V_{GS}=10V$, $L=0.5mH$, $I_{AS}=22A$

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